

1. General description

N-channel enhancement mode Field-Effect Transistor (FET) in an MLPAK33 (SOT8002) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

2. Features and benefits

- Logic-level compatible
- Trench MOSFET technology
- · Ultra low Q_G and Q_{GD} for high system efficiency, especially at higher switching frequencies
- Superfast switching with soft-recovery
- Low spiking and ringing for low EMI designs
- MLPAK33 package (3.3 x 3.3 mm footprint)

3. Applications

- DC to DC conversion
- Battery management
- Low-side load switch
- Switching circuits

4. Quick reference data

Table 1. Qui							
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{DS}	drain-source voltage	T _j = 25 °C		-	-	25	V
V _{GS}	gate-source voltage			-20	-	20	V
I _D	drain current	V _{GS} = 10 V; T _{amb} = 25 °C; t ≤ 5 s	[1]	-	-	22.3	А
Static chara	acteristics						
R _{DSon}	R _{DSon} drain-source on-state resistance	V _{GS} = 10 V; I _D = 13.1 A; T _j = 25 °C		-	5.3	6.2	mΩ
		V _{GS} = 4.5 V; I _D = 11.2 A; T _j = 25 °C		-	6.8	8.5	mΩ
Dynamic ch	naracteristics						
Q _{G(tot)}	total gate charge	V_{DS} = 12.5 V; I _D = 11.2 A; V _{GS} = 4.5 V; T _j = 25 °C		-	8.1	12.2	nC

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm².

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5. Pinning information

Table 2	Table 2. Pinning information							
Pin	Symbol	Description	Simplified outline	Graphic symbol				
1	S	source	1 2 3 4					
2	S	source	رففف ا					
3	S	source		D				
4	G	gate	Ę ₽					
5	D	drain		G L H A				
6	D	drain	Церей	mbb076 S				
7	D	drain						
8	D	drain	MLPAK33 (SOT8002-1)					

6. Ordering information

Table 3. Ordering information Type number	on Package					
	Name	Description	Version			
PXN6R2-25QL		plastic thermal enhanced surface mounted package; mini leads; 8 terminals; pitch 0.65 mm; 3.3 x 3.3 x 0.8 mm body	SOT8002-1			

7. Marking

Table 4. Marking codes	
Type number	Marking code
PXN6R2-25QL	9AG

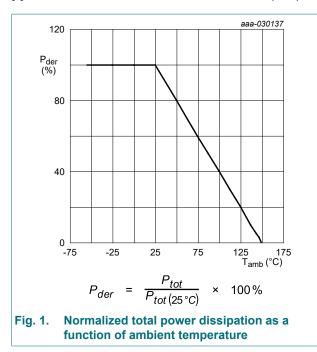
8. Limiting values

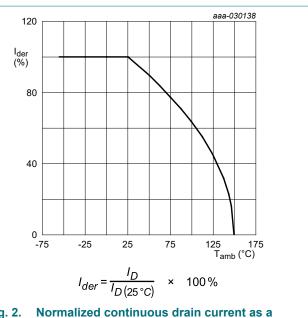
Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	T _j = 25 °C		-	25	V
V _{GS}	gate-source voltage	-		-20	20	V
I _D	drain current	V _{GS} = 10 V; T _{amb} = 25 °C; t ≤ 5 s	[1]	-	22.3	А
		V _{GS} = 10 V; T _{amb} = 25 °C	[1]	-	13.1	А
		V _{GS} = 10 V; T _{amb} = 100 °C	[1]	-	8.3	А
		V _{GS} = 10 V; T _{sp} = 25 °C		-	65	А
I _{DM}	peak drain current	T_{amb} = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	90	А
P _{tot}	total power dissipation	T _{amb} = 25 °C; t ≤ 5 s	[1]	-	4.8	W
		T _{amb} = 25 °C	[1]	-	1.7	W
		T _{sp} = 25 °C		-	40.3	W
Tj	junction temperature			-55	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C
Source-drain c	liode					
Is	source current	T _{amb} = 25 °C	[1]	-	1.5	А
Avalanche rug	gedness	•				
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	T _{j(init)} = 25 °C; I _D = 2.4 A; DUT in avalanche (unclamped)		-	30	mJ

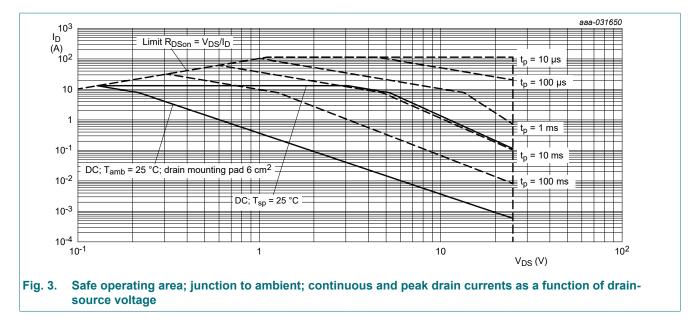
[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm².







25 V, N-channel Trench MOSFET

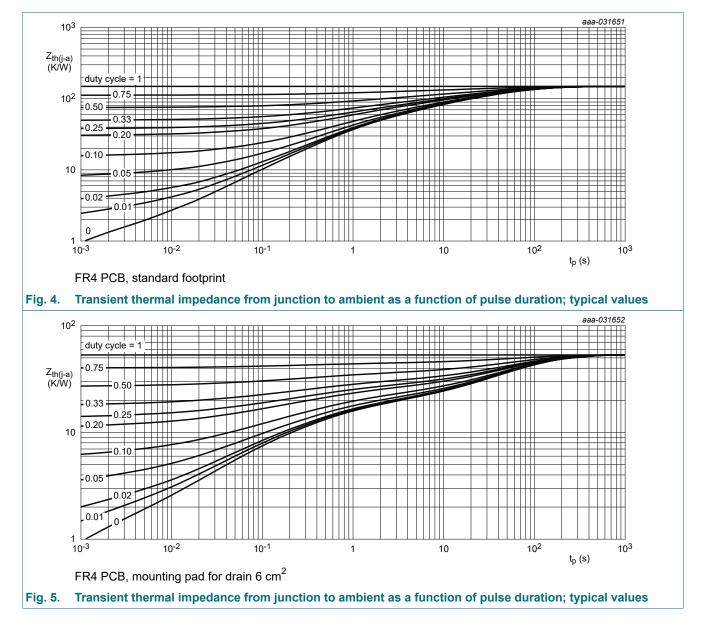


9. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	[1]	-	150	190	K/W
			[2]	-	60	75	K/W
		in free air; t ≤ 5 s	[2]	-	21	26	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point			-	2.1	3.1	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

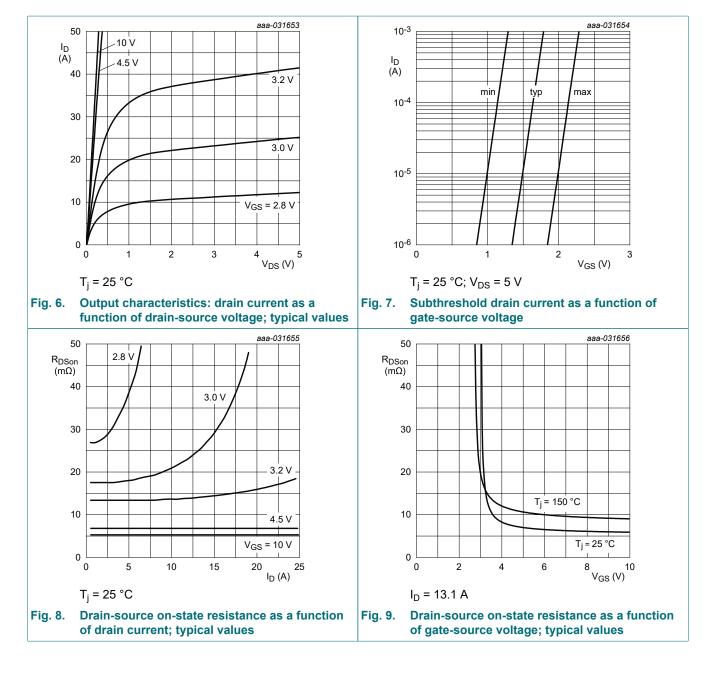
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 cm².



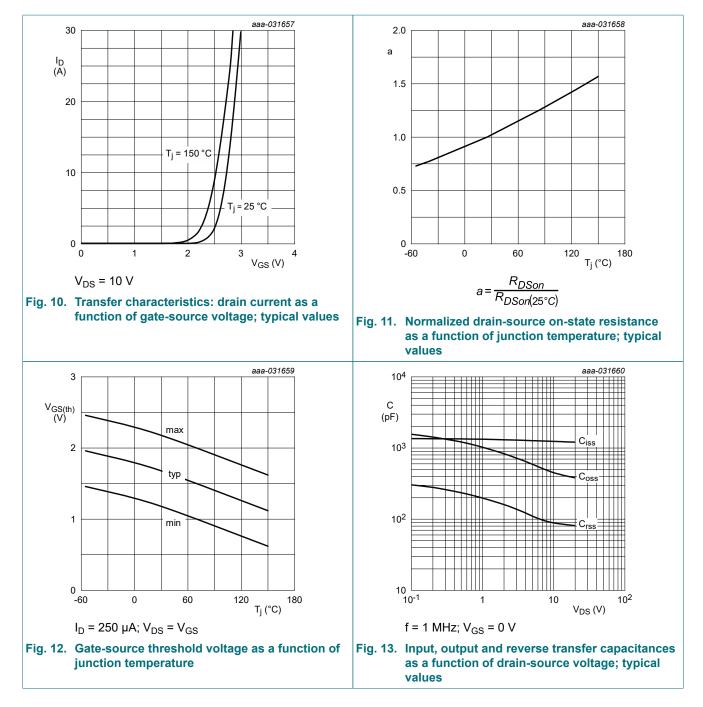
10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Static chara	cteristics					
V _{(BR)DSS}	drain-source breakdown voltage	I _D = 250 μA; V _{GS} = 0 V; T _j = 25 °C	25	-	-	V
V _{GSth}	gate-source threshold voltage	I _D = 250 μA; V _{DS} = V _{GS} ; T _j = 25 °C	1.2	1.7	2.2	V
I _{DSS}	drain leakage current	V _{DS} = 25 V; V _{GS} = 0 V; T _j = 25 °C	-	-	1	μA
I _{GSS}	gate leakage current	V _{GS} = 20 V; V _{DS} = 0 V; T _j = 25 °C	-	-	100	nA
		V _{GS} = -20 V; V _{DS} = 0 V; T _j = 25 °C	-	-	-100	nA
R _{DSon}	drain-source on-state	V _{GS} = 10 V; I _D = 13.1 A; T _j = 25 °C	-	5.3	6.2	mΩ
	resistance	V _{GS} = 10 V; I _D = 13.1 A; T _j = 150 °C	-	8.2	9.7	mΩ
		V _{GS} = 4.5 V; I _D = 11.2 A; T _j = 25 °C	-	6.8	8.5	mΩ
9 _{fs}	forward transconductance	V _{DS} = 10 V; I _D = 13.1 A; T _j = 25 °C	-	32	-	S
R _G	gate resistance	f = 1 MHz	-	11.5	-	Ω
-	aracteristics	1	I			
Q _{G(tot)}	total gate charge	V_{DS} = 12.5 V; I_D = 13.1 A; V_{GS} = 10 V; T _i = 25 °C	-	17	25.5	nC
		V _{DS} = 12.5 V; I _D = 11.2 A; V _{GS} = 4.5 V;	-	8.1	12.2	nC
Q _{GS}	gate-source charge	T _j = 25 °C	-	3.2	-	nC
Q _{GS(th)}	pre-threshold gate- source charge		-	2	-	nC
Q _{GS(th-pl)}	post-threshold gate- source charge		-	1.2	-	nC
Q _{GD}	gate-drain charge	1	-	2.2	-	nC
V _{GSpl}	gate-source plateau voltage	V _{DS} = 12.5 V; I _D = 11.2 A; T _j = 25 °C	-	2.8	-	V
C _{iss}	input capacitance	V _{DS} = 12.5 V; f = 1 MHz; V _{GS} = 0 V;	-	1200	-	pF
C _{oss}	output capacitance	T _j = 25 °C	-	430	-	pF
C _{rss}	reverse transfer capacitance		-	76	-	pF
t _{d(on)}	turn-on delay time	V _{DS} = 12.5 V; I _D = 11.2 A; V _{GS} = 4.5 V;	-	5	-	ns
t _r	rise time	R _{G(ext)} = 5 Ω; T _j = 25 °C	-	8	-	ns
t _{d(off)}	turn-off delay time	1 – –	-	6	-	ns
t _f	fall time	1 – –	-	3	-	ns
Source-drai	n diode		I			
V _{SD}	source-drain voltage	I _S = 1.5 A; V _{GS} = 0 V; T _i = 25 °C	-	0.7	1.2	V
t _{rr}	reverse recovery time	I _S = 1.5 A; dI _S /dt = -100 A/µs;	-	15	-	ns
Q _r	recovered charge	V _{GS} = 4.5 V; V _{DS} = 12.5 V; T _j = 25 °C	-	6	-	nC
t _a	reverse recovery rise time	1	-	8	-	ns
t _b	reverse recovery fall time	1	-	7	-	ns

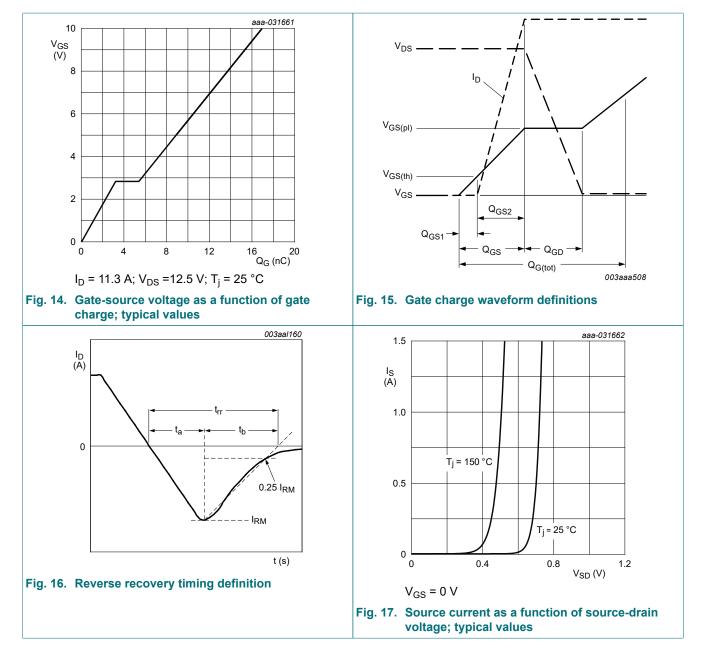
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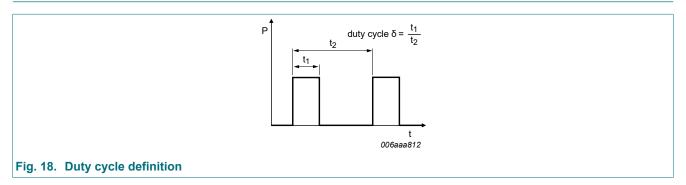
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25 V, N-channel Trench MOSFET

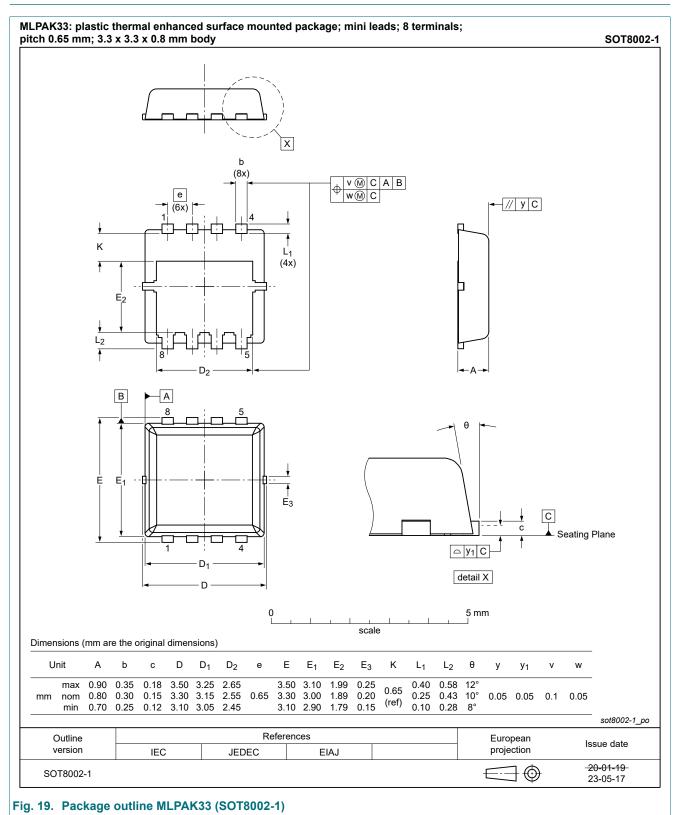


11. Test information

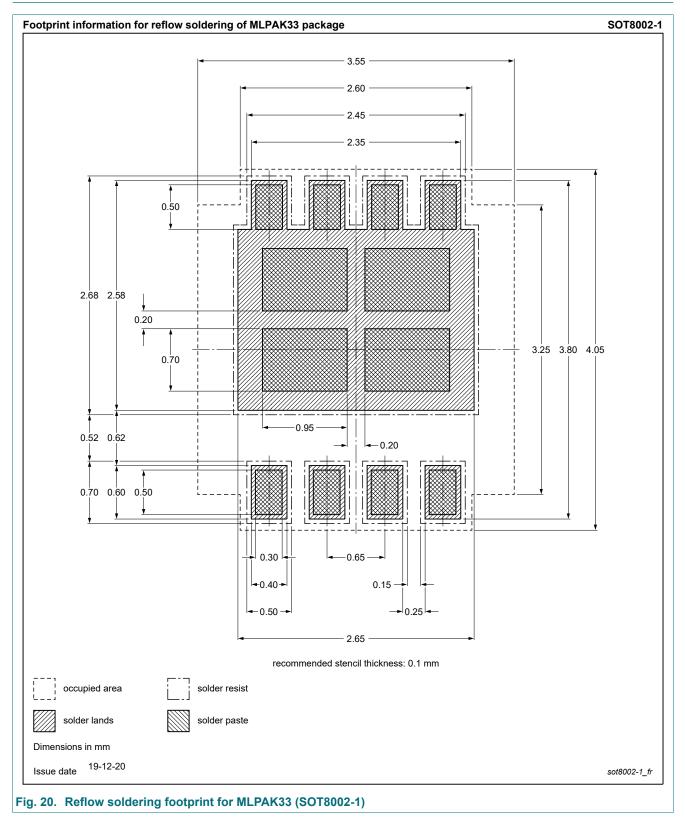


PXN6R2-25QL

12. Package outline



13. Soldering



14. Revision history

Table 8. Revision history							
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes			
PXN6R2-25QL v.2	20230731	Product data sheet	-	PXN6R2-25QL v.1			
Modifications:	Chapter "Package of	Chapter "Package outline": drawing update					
PXN6R2-25QL v.1	20201102	Product data sheet	-	-			

PXN6R2-25QL

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <u>https://www.nexperia.com</u>.

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